6×8 DOTS MATRIX LED DRIVER WITH INDIVIDUAL AUTO BREATH FUNCTION

August 2022

GENERAL DESCRIPTION

The IS31FL3738 is a general purpose 6×8 LEDs matrix driver with 1/12 cycle rate. The device can be programmed via an I2C compatible interface. Each LED can be dimmed individually with 8-bit × 4 PWM data which allowing 512 steps of linear dimming.

IS31FL3738 features 3 Auto Breathing Modes which are noted as ABM-1, ABM-2 and ABM-3. For each Auto Breathing Mode, there are 4 timing characters which include current rising / holding / falling / off time and 3 loop characters which include Loop-Beginning / Loop-Ending / Loop-Times. Every LED can be configured to be any Auto Breathing Mode or No-Breathing Mode individually.

Additionally each LED open and short state can be detected, IS31FL3738 store the open or short information in Open-Short Registers. The Open-Short Registers allowing MCU to read out via I2C compatible interface. Inform MCU whether there are LEDs open or short and the locations of open or short LEDs.

The IS31FL3738 operates from 2.7V to 5.5V and features a very low shutdown and operational current.

IS31FL3738 is available in QFN-28 (5mm×5mm) and eTSSOP-28 packages. It operates from 2.7V to 5.5V over the temperature range of -40°C to +125°C.

FEATURES

- Supply voltage range: 2.7V to 5.5V
- 8 current source outputs for row control
- 6 switch current inputs for column scan control
- Up to 48 LEDs (6×8) in dot matrix
- Programmable 6×8 (16 RGBs) matrix size with de-ghost function
- 1MHz I2C-compatible interface
- Selectable 3 Auto Breath Modes for each dot
- Auto Breath Loop Features interrupt pin inform MCU Auto Breath Loop completed
- Auto Breath offers 128 steps gamma current, interrupt and state look up registers
- 256 steps global current setting
- Individual on/off control
- Individual 512 PWM control steps
- Individual Auto Breath Mode select
- Individual open and short error detect function
- Cascade for synchronization of chips
- QFN-28 (5mm×5mm) and eTSSOP-28 packages

APPLICATIONS

- Mobile phones and other hand-held devices for LED display
- Gaming device (keyboard, mouse etc.)
- LED in white goods application

TYPICAL APPLICATION CIRCUIT

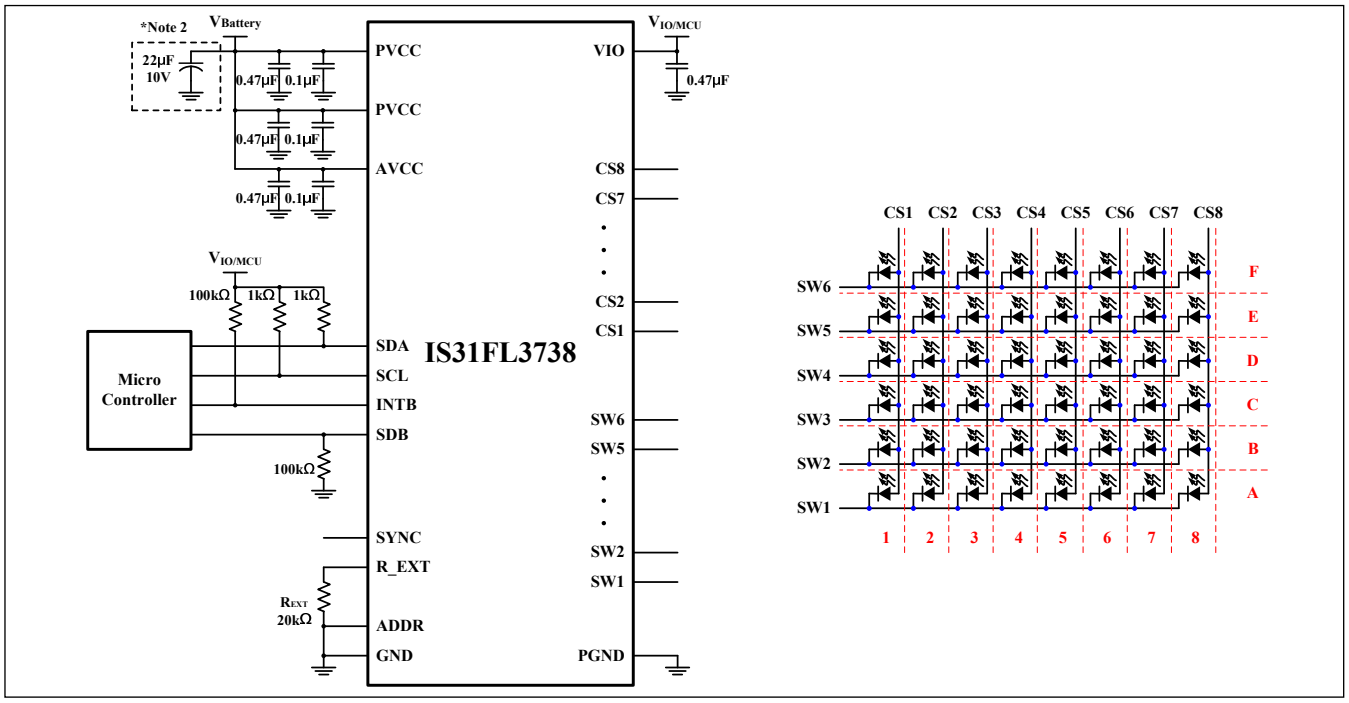


Figure 1 Typical Application Circuit (6×8)

TYPICAL APPLICATION CIRCUIT (CONTINUED)

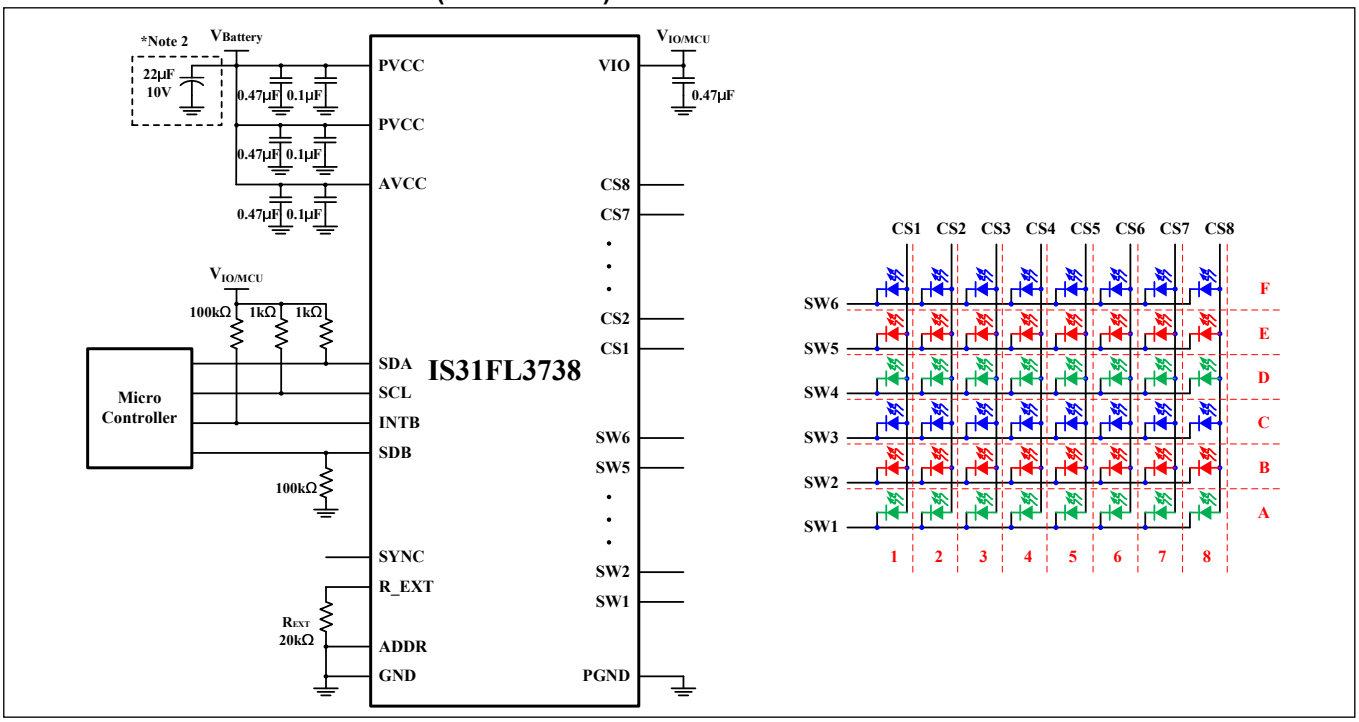


Figure 2 Typical Application Circuit (RGB)

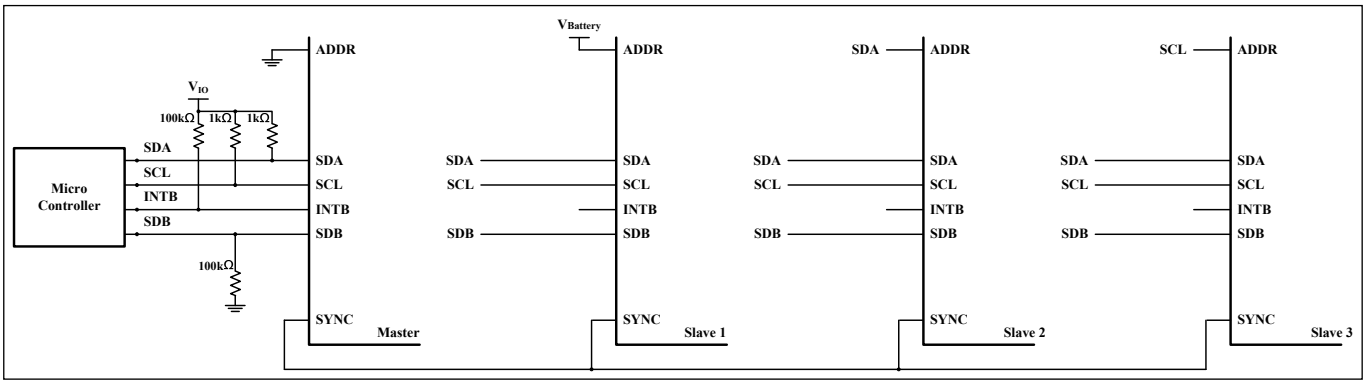


Figure 3 Typical Application Circuit (Four Parts Synchronization-Work)

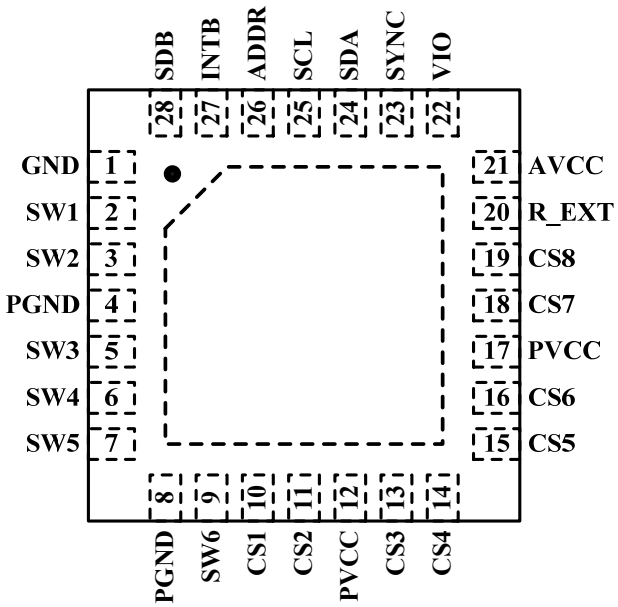
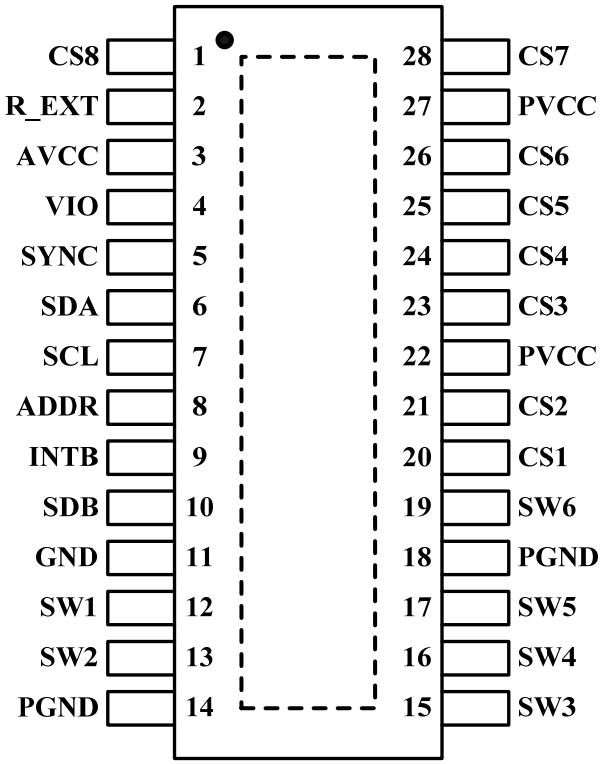
Note 1: For the mobile applications the IC should be placed far away from the mobile antenna in order to prevent the EMI.

Note 2: Electrolytic/Tantalum Capacitor may considerable for high current application to avoid audible noise interference.

Note 3: One part is configured as master mode, all the other 3 parts configured as slave mode. Work as master mode or slave mode specified by Configuration Register (Function Register, address 00h). Master part output master clock, and all the other parts which work as slave input this master clock.

Note 4: The VIO should be 1.8V≤ V_{IO} ≤V_{CC}. And it is recommended to be equal to V_{OH} of the micro controller. For example, if V_{OH}=1.8V, set V_{IO}=1.8V is recommended.

PIN CONFIGURATION

Package	Pin Configuration (Top View)
QFN-28	
eTSSOP-28	

PIN DESCRIPTION

No.		Pin	Description
QFN	eTSSOP		
1	11	GND	Ground
2,3	12,13	SW1, SW2	Switch pin for LED matrix scanning.
4,8	14,18	PGND	Power GND, connect to GND.
5~7	15~17	SW3~ SW5	Switch pin for LED matrix scanning.
9	19	SW6	Switch pin for LED matrix scanning.
10,11	20,21	CS1, CS2	Current source.
12,17	22,27	PVCC	Power for current source.
13~16	23~26	CS3~ CS6	Current source.
18, 19	28,1	CS7, CS8	Current source.
20	2	R_EXT	Input terminal used to connect an external resistor. This regulates current source DC current value.
21	3	AVCC	Power for analog circuits.
22	4	VIO	Input logic reference voltage.
23	5	SYNC	Synchronize pin. It is used for more than one part work synchronize. If it is not used please float this pin.
24	6	SDA	I2C compatible serial data.
25	7	SCL	I2C compatible serial clock.
26	8	ADDR	I2C address setting.
27	9	INTB	Interrupt output pin. Register F0h sets the function of the INTB pin and active low when the interrupt event happens. Can be NC (float) if interrupt function no used.
28	10	SDB	Shutdown the chip when pull to low.
		Thermal Pad	Need to connect to GND pins.

ORDERING INFORMATION

Industrial Range: -40°C to +125°C

Order Part No.	Package	QTY/Reel
IS31FL3738-QFLS4-TR IS31FL3738-ZLS4-TR	QFN-28, Lead-free eTSSOP-28, Lead-free	2500

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a.) the risk of injury or damage has been minimized;
b.) the user assume all such risks; and
c.) potential liability of Lumissil Microsystems is adequately protected under the circumstances

ABSOLUTE MAXIMUM RATINGS

Supply voltage, V_{CC}	-0.3V ~ +6.0V
Voltage at any input pin	-0.3V ~ V_{CC}+0.3V
Maximum junction temperature, T_{JMAX}	+150°C
Storage temperature range, T_{STG}	-65°C ~ +150°C
Operating temperature range, T_A=T_J	-40°C ~ +125°C
Package thermal resistance, junction to ambient (4-layer standard test PCB based on JEDEC standard), θ_{JA}	41.5°C/W (QFN) 30.08°C/W (eTSSOP)
ESD (HBM) ESD (CDM)	±2kV ±750V

Note: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

The following specifications apply for V_{CC} = 3.6V, T_A = 25°C, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage		2.7		5.5	V
V_{IO}	Input logic reference voltage		1.8		V_{CC}	V
I_{CC}	Quiescent power supply current	V_{SDB} = V_{CC}, all LEDs off		2.17		mA
I_{SD}	Shutdown current	V_{SDB} = 0V		3		μA
		V_{SDB} = V_{CC}, Configuration Register written "0000 0000		3		
I_{OUT}	Maximum constant current of CS1~CS8	R_{EXT}=20kΩ		84		mA
I_{LED}	Average current on each LED I_{LED} = (I_{OUT}/2/12.75)×4	R_{EXT}= 20kΩ, GCC= 255, PWM= 255		13.2		mA
V_{HR}	Current sink headroom voltage SW1~SW6	I_{SINK}= 672mA (Note 1, 2)		350		mV
	Current source headroom voltage CS1~CS8	I_{SOURCE}= 84mA (Note 1)		350		
t_{SCAN}	Period of scanning			128		μs
t_{NOL}	Non-overlap blanking time during scan, the SWy and CSx are all off during this time			8		μs
Logic Electrical Characteristics (SDA, SCL, ADDR, SYNC, SDB)						
V_{IL}	Logic "0" input voltage	V_{IO}=3.6V	GND		0.2V_{IO}	V
V_{IH}	Logic "1" input voltage	V_{IO}=3.6V	0.75V_{IO}		V_{IO}	V
V_{HYS}	Input schmitt trigger hysteresis	V_{IO}=3.6V		0.2		V
V_{OL}	Logic "0" output voltage for SYNC	I_{OL}= 8mA			0.4	V
V_{OH}	Logic "1" output voltage for SYNC	I_{OH}= 8mA	0.75V_{IO}			V
I_{IL}	Logic "0" input current	V_{INPUT}= 0V (Note 3)		5		nA
I_{IH}	Logic "1" input current	V_{INPUT}= V_{IO} (Note 3)		5		nA

DIGITAL INPUT SWITCHING CHARACTERISTICS (NOTE 3)

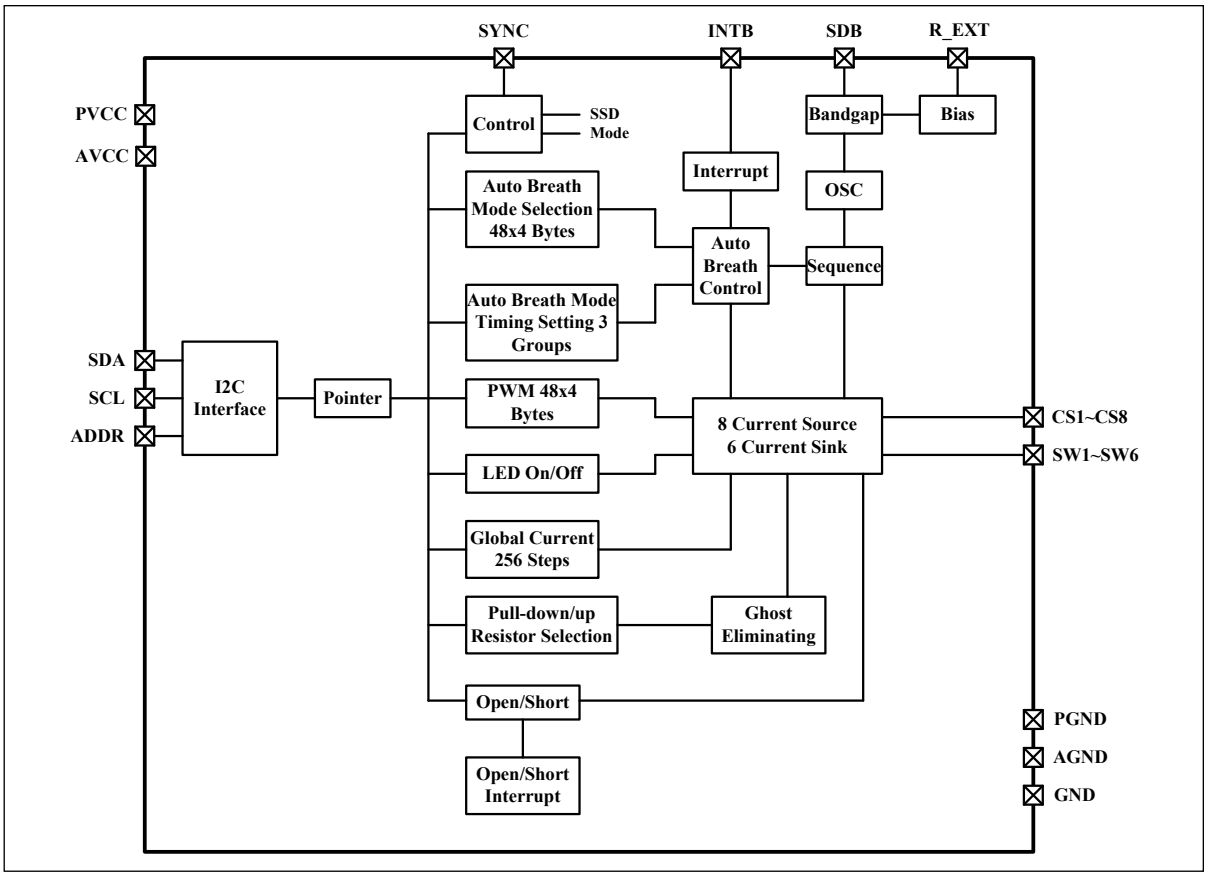
Symbol	Parameter	Fast Mode			Fast Mode Plus			Units
		Min.	Typ.	Max	Min.	Typ.	Max.	
f_{SCL}	Serial-clock frequency	-		400	-		1000	kHz
t_{BUF}	Bus free time between a STOP and a START condition	1.3		-	0.5		-	µs
$t_{HD, STA}$	Hold time (repeated) START condition	0.6		-	0.26		-	µs
$t_{SU, STA}$	Repeated START condition setup time	0.6		-	0.26		-	µs
$t_{SU, STO}$	STOP condition setup time	0.6		-	0.26		-	µs
$t_{HD, DAT}$	Data hold time	-		-	-		-	µs
$t_{SU, DAT}$	Data setup time	100		-	50		-	ns
t_{LOW}	SCL clock low period	1.3		-	0.5		-	µs
t_{HIGH}	SCL clock high period	0.7		-	0.26		-	µs
t_R	Rise time of both SDA and SCL signals, receiving	-		300	-		120	ns
t_F	Fall time of both SDA and SCL signals, receiving	-		300	-		120	ns

Note 1: In case of R_{EXT} = 20kΩ, Global Current Control Register (PG3, 01h) written “1111 1111”, GCC = “1111 1111”.

Note 2: All LEDs are on and PWM = “1111 1111”, GCC = “1111 1111”.

Note 3: Guaranteed by design.

FUNCTIONAL BLOCK DIAGRAM



DETAILED DESCRIPTION

I2C INTERFACE

The IS31FL3738 uses a serial bus, which conforms to the I2C protocol, to control the chip's functions with two wires: SCL and SDA. The IS31FL3738 has a 7-bit slave address (A7:A1), followed by the R/W bit, A0. Set A0 to "0" for a write command and set A0 to "1" for a read command. The value of bits A4:A1 are decided by the connection of the ADDR pin. The complete slave address is:

Table 1 Slave Address:

ADDR2	ADDR1	A7:A5	A4:A1	A0
GND	GND	101	0000	0/1
SCL	SCL		0101	
SDA	SDA		1010	
VCC	VCC		1111	

ADDR connected to GND, (A4:A1)=0000;
ADDR connected to VCC, (A4:A1)=1111;
ADDR connected to SCL, (A4:A1)=0101;
ADDR connected to SDA, (A4:A1)=1010;

The SCL line is uni-directional. The SDA line is bi-directional (open-collector) with a pull-up resistor (typically 1kΩ). The maximum clock frequency specified by the I2C standard is 1MHz. In this discussion, the master is the microcontroller and the slave is the IS31FL3738.

The timing diagram for the I2C is shown in Figure 4. The SDA is latched in on the stable high level of the SCL. When there is no interface activity, the SDA line should be held high.

The "START" signal is generated by lowering the SDA signal while the SCL signal is high. The start signal will alert all devices attached to the I2C bus to check the incoming address against their own chip address.

The 8-bit chip address is sent next, most significant bit first. Each address bit must be stable while the SCL level is high.

After the last bit of the chip address is sent, the master checks for the IS31FL3738's acknowledge. The master releases the SDA line high (through a pull-up resistor). Then the master sends an SCL pulse. If the IS31FL3738 has received the address correctly, then it holds the SDA line low during the SCL pulse. If the SDA line is not low, then the master should send a "STOP" signal (discussed later) and abort the transfer.

Following acknowledge of IS31FL3738, the register address byte is sent, most significant bit first. IS31FL3738 must generate another acknowledge indicating that the register address has been received.

Then 8-bit of data byte are sent next, most significant bit first. Each data bit should be valid while the SCL level is stable high. After the data byte is sent, the IS31FL3738 must generate another acknowledge to indicate that the data was received.

The "STOP" signal ends the transfer. To signal "STOP", the SDA signal goes high while the SCL signal is high.

ADDRESS AUTO INCREMENT

To write multiple bytes of data into IS31FL3738, load the address of the data register that the first data byte is intended for. During the IS31FL3738 acknowledge of receiving the data byte, the internal address pointer will increment by one. The next data byte sent to IS31FL3738 will be placed in the new address, and so on. The auto increment of the address will continue as long as data continues to be written to IS31FL3738 (Figure 7).

READING OPERATION

Register FEh, F1h and 18h~2Dh, 30h~45h of Page 0, 11h of Page 3 can be read.

To read the FEh and F1h, after I2C start condition, the bus master must send the IS31FL3738 device address with the R/$\overline{W}$ bit set to "0", followed by the register address (FEh or F1h) which determines which register is accessed. Then restart I2C, the bus master should send the IS31FL3738 device address with the R/$\overline{W}$ bit set to "1". Data from the register defined by the command byte is then sent from the CHROMA-96 to the master (Figure 8).

To read the 18h~2Dh, 30h~45h of Page 0, 11h of Page 3, the FDh should write with 00h before follow the Figure 8 sequence to read the data, that means, when you want to read 18h~2Dh, 30h~45h of Page 0, 11h of Page 3, the FDh should point to Page 0 or Page 3 first and you can read the Page 0 and Page 3 data.

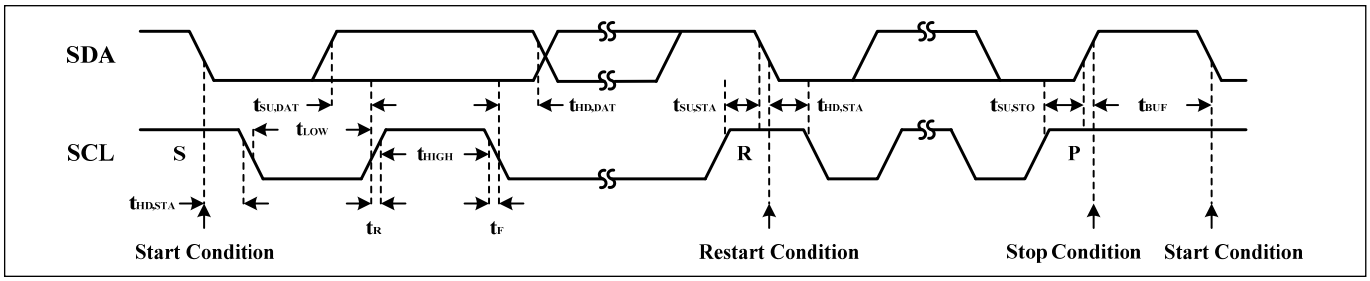


Figure 4 Interface Timing

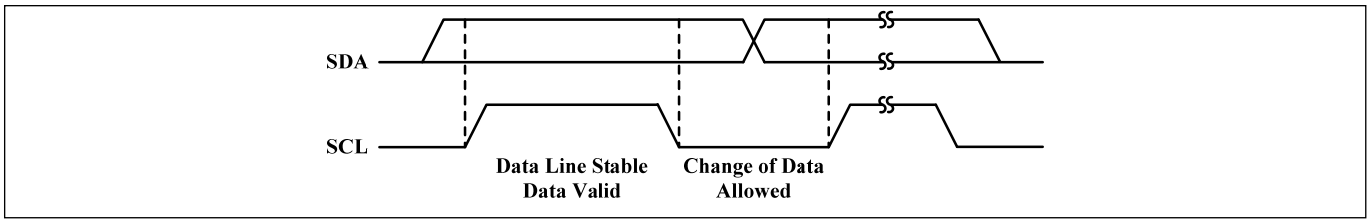


Figure 5 Bit Transfer

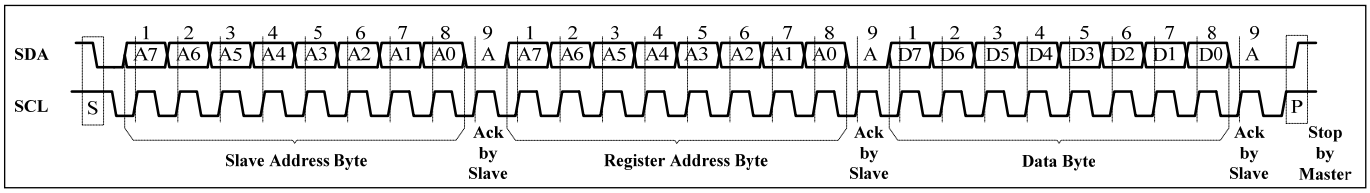


Figure 6 Writing to IS31FL3738 (Typical)

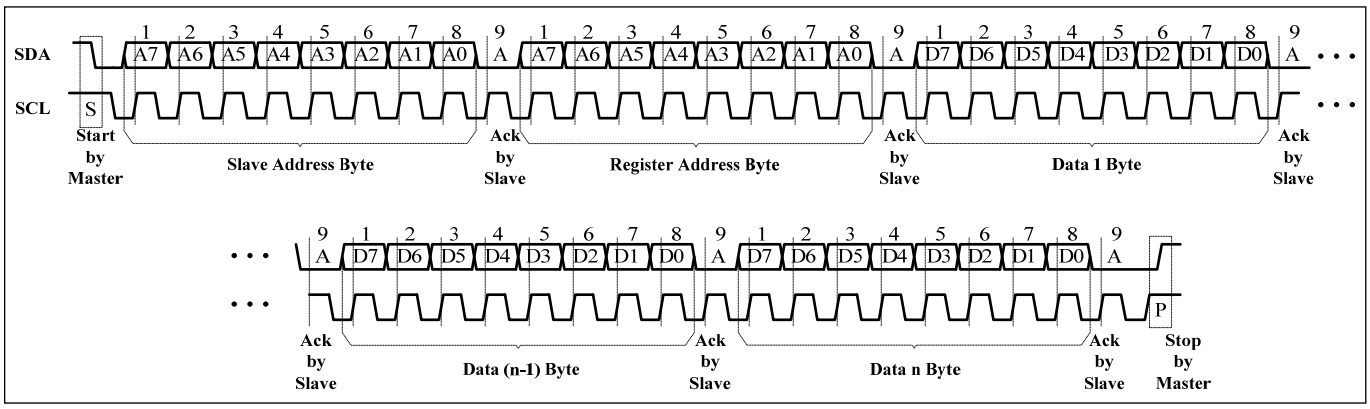


Figure 7 Writing to IS31FL3738 (Automatic Address Increment)

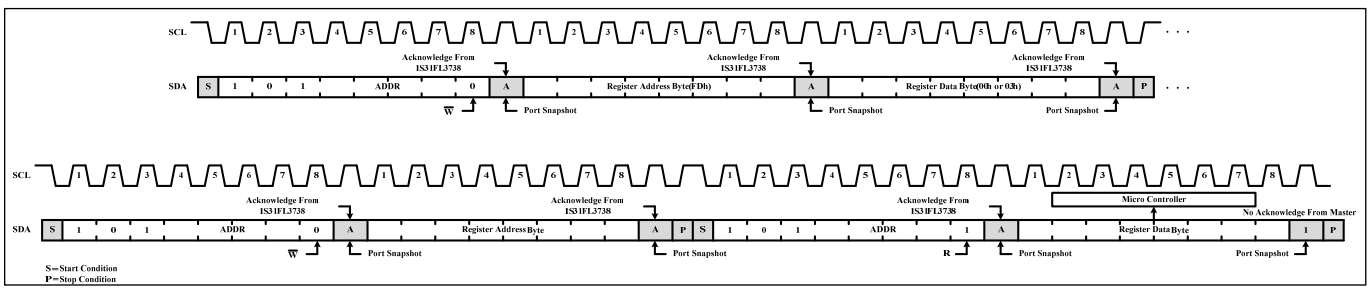


Figure 8 Reading from IS31FL3738

REGISTER DEFINITION-1

Address	Name	Function	Table	R/W	Default
FDh	Command Register	Available Page 0 to Page 3 Registers	2	W	xxxx xxxx
FEh	Command Register Write Lock	To lock/unlock Command Register	3	R/W	0000 0000
F0h	Interrupt Mask Register	Configure the interrupt function	4	W	
F1h	Interrupt Status Register	Show the interrupt status	5	R	

REGISTER CONTROL

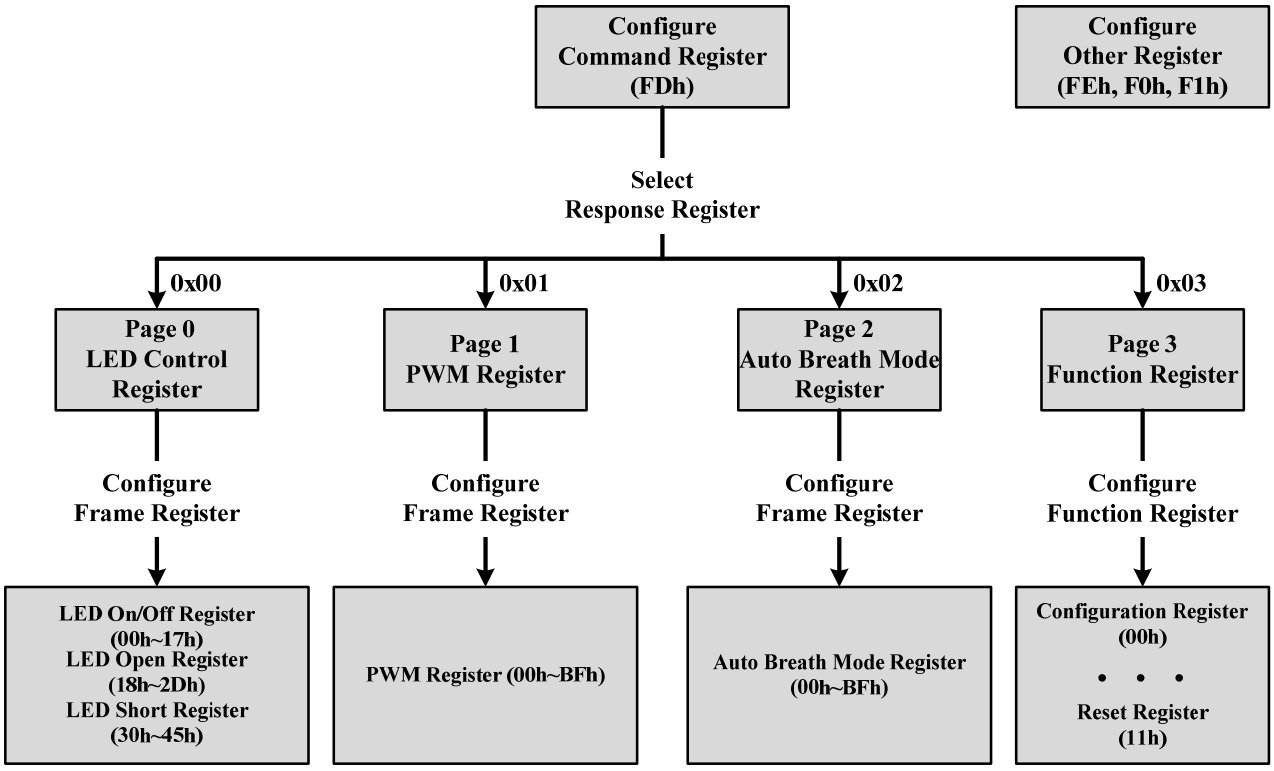


Table 2 FDh Command Register (Write Only)

Data	Function
0000 0000	Point to Page 0 (PG0, LED Control Register is available)
0000 0001	Point to Page 1 (PG1, PWM Register is available)
0000 0010	Point to Page 2 (PG2, Auto Breath Mode Register is available)
0000 0011	Point to Page 3 (PG3, Function Register is available)
Others	Reserved

Note: FDh is locked when power up, need to unlock this register before write command to it. See Table 3 for detail.

The Command Register should be configured first after writing in the slave address to choose the available register. Then write data in the choosing register. Power up default state is "0000 0000".

For example, when write "0000 0001" in the Command Register (FDh), the data which writing after will be stored in the Auto breath mode Register. Write new data can configure other registers.

Table 3 FEh Command Register Write Lock (Read/Write)

Bit	D7:D0
Name	CRWL
Default	0000 0000 (FDh write disable)

To select the PG0~PG3, need to unlock this register first, with the purpose to avoid misoperation of this register. When FEh is written with 0xC5, FDh is allowed to modify once, after the FDh is modified the FEh will reset to be 0x00 at once.

CRWL Command Register Write Lock
0x00 FDh write disable
0xC5 FDh write enable once

Table 4 F0h Interrupt Mask Register

Bit	D7:D4	D3	D2	D1	D0
Name	-	IAC	IAB	IS	IO
Default	0000	0	0	0	0

Configure the interrupt function for IC.

IAC Auto Clear Interrupt Bit
0 Interrupt could not auto clear
1 Interrupt auto clear when INTB stay low exceeds 8ms

IAB Auto Breath Interrupt Bit
0 Disable auto breath loop finish interrupt
1 Enable auto breath loop finish interrupt

IS Dot Short Interrupt Bit
0 Disable dot short interrupt
1 Enable dot short interrupt

IO Dot Open Interrupt Bit
0 Disable dot open interrupt
1 Enable dot open interrupt

Table 5 F1h Interrupt Status Register

Bit	D7:D5	D4	D3	D2	D1	D0
Name	-	ABM3	ABM2	ABM1	SB	OB
Default	000	0	0	0	0	0

Show the interrupt status for IC.

ABM3 Auto Breath Mode 3 Finish Bit
0 ABM3 not finish
1 ABM3 finish

ABM2 Auto Breath Mode 2 Finish Bit
0 ABM2 not finish
1 ABM2 finish

ABM1 Auto Breath Mode 1 Finish Bit
0 ABM1 not finish
1 ABM1 finish

SB Short Bit
0 No short
1 Short happens

OB Open Bit
0 No open
1 Open happens

REGISTER DEFINITION-2

Address	Name	Function	Table	R/W	Default
PG0 (0x00): LED Control Register					
00h ~ 17h	LED On/Off Register	Set on or off state for each LED	7	W	0000 0000
18h ~ 2Dh	LED Open Register	Store open state for each LED	8	R	
30h ~ 45h	LED Short Register	Store short state for each LED	9	R	
PG1 (0x01): PWM Register					
00h~BFh	PWM Register	Set PWM duty for LED	10	W	0000 0000
PG2 (0x02): Auto Breath Mode Register					
00h~BFh	Auto Breath Mode Register	Set operating mode of each dot	11	W	0000 0000
PG3 (0x03) : Function Register					
00h	Configuration Register	Configure the operation mode	13	W	0000 0000
01h	Global Current Control Register	Set the global current	14	W	
02h	Auto Breath Control Register 1 of ABM-1	Set fade in and hold time for breath function of ABM-1	15	W	
03h	Auto Breath Control Register 2 of ABM-1	Set the fade out and off time for breath function of ABM-1	16	W	
04h	Auto Breath Control Register 3 of ABM-1	Set loop characters of ABM-1	17	W	
05h	Auto Breath Control Register 4 of ABM-1	Set loop characters of ABM-1	18	W	
06h	Auto Breath Control Register 1 of ABM-2	Set fade in and hold time for breath function of ABM-2	15	W	
07h	Auto Breath Control Register 2 of ABM-2	Set the fade out and off time for breath function of ABM-2	16	W	
08h	Auto Breath Control Register 3 of ABM-2	Set loop characters of ABM-2	17	W	
09h	Auto Breath Control Register 4 of ABM-2	Set loop characters of ABM-2	18	W	
0Ah	Auto Breath Control Register 1 of ABM-3	Set fade in and hold time for breath function of ABM-3	15	W	
0Bh	Auto Breath Control Register 2 of ABM-3	Set the fade out and off time for breath function of ABM-3	16	W	
0Ch	Auto Breath Control Register 3 of ABM-3	Set loop characters of ABM-3	17	W	
0Dh	Auto Breath Control Register 4 of ABM-3	Set loop characters of ABM-3	18	W	
0Eh	Time Update Register	Update the setting of 02h ~ 0Dh registers	-	W	
0Fh	SWy Pull-Up Resistor Selection Register	Set the pull-up resistor for SWy	19	W	
10h	CSx Pull-Down Resistor Selection Register	Set the pull-down resistor for CSx	20	W	
11h	Reset Register	Reset all register to POR state	-	R	

Table 6-1 Page 0 (PG0, 0x00): LED Control Register - On Off Register

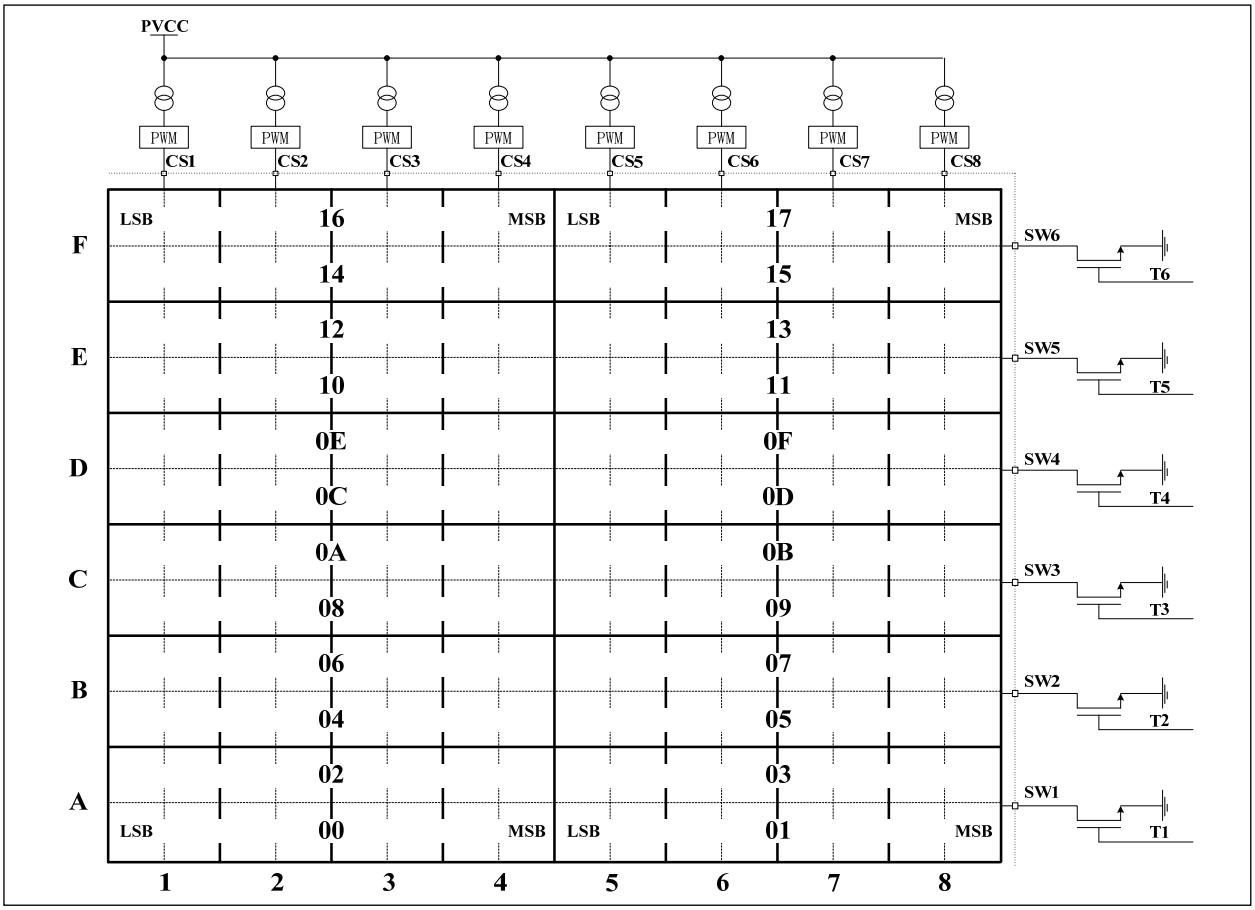


Figure 9 On off Register

Table 7 00h ~ 17h LED On/Off Register

Bit	D7:D0
Name	C_{CS8} : C_{CS1} or C_{CS16} : C_{CS9}
Default	0000 0000

The LED On/Off Registers store the on or off state of each LED in the Matrix.

Each LED has 4 bits on and off state, need to turn on/off them when turn on/off the LED.

For example:

When turn on LED 1-A, need to turn on

D1:D0 of 00h, and D1:D0 of 02h

C_{X-Y}	LED State Bit
0	LED off
1	LED on

Table 6-2 Page 0 (PG0, 0x00): LED Control Register – Open Detect Register

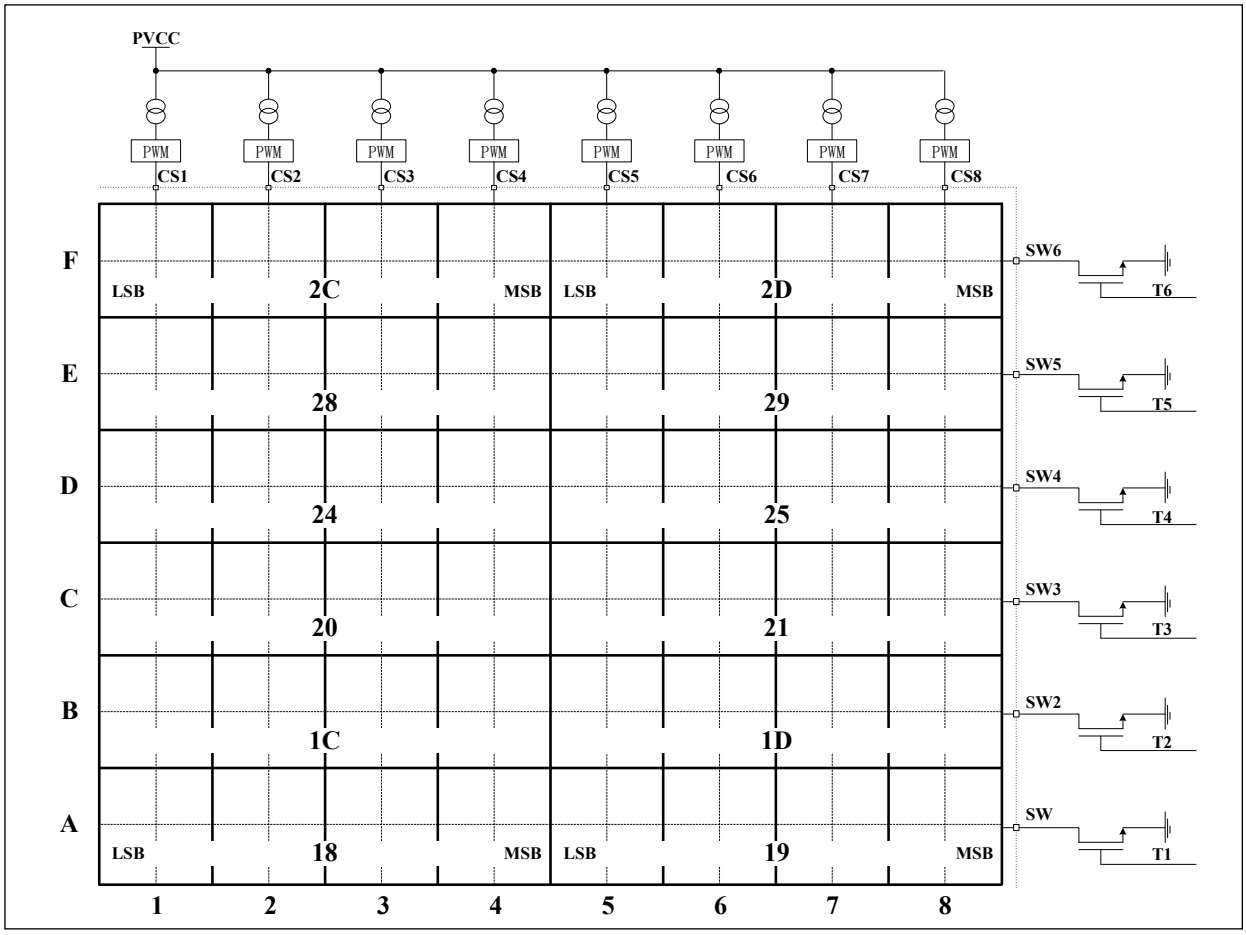


Figure 10 On off Register

Table 8 18h ~ 2Dh LED Open Register

Bit	D7	D6	D5	D4	D3	D2	D1	D0
Name	OP_8	-	OP_6	-	OP_4	-	OP_2	-
Default	0	-	0	-	0	-	0	-

The LED Open Registers store the open or normal state of each LED in the Matrix.

OPx LED Open Bit
0 LED normal
1 LED open

Table 6-3 Page 0 (PG0, 0x00): LED Control Register – Short Detect Register

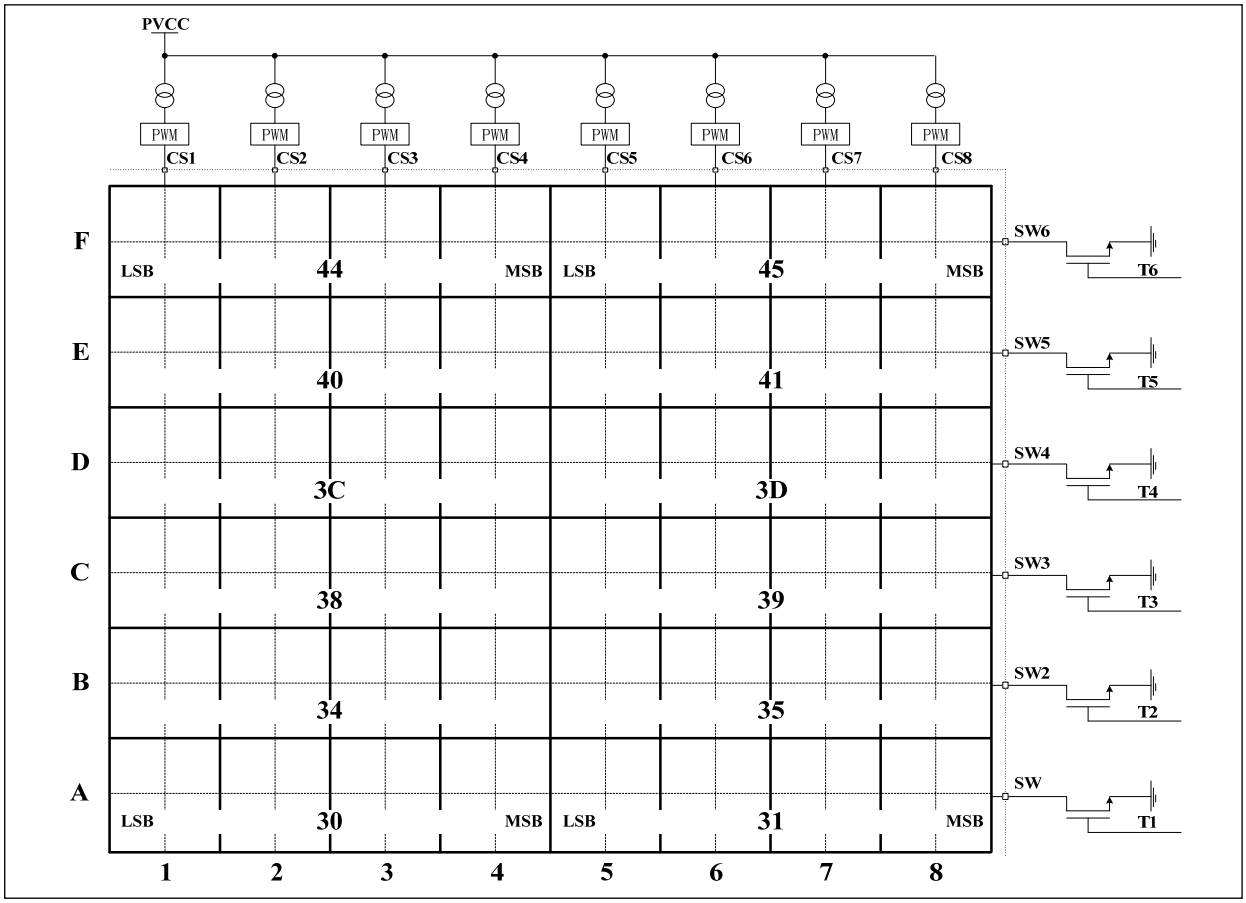


Figure 10 On off Register

Table 9 30h ~ 45h LED Short Register

Bit	D7	D6	D5	D4	D3	D2	D1	D0
Name	ST_8	-	ST_6	-	ST_4	-	ST_2	-
Default	0	-	0	-	0	-	0	-

The LED Short Registers store the short or normal state of each LED in the Matrix.

OPx	LED Short Bit
0	LED normal
1	LED short

Table 6-4 Page 1 (PG1, 0x01): PWM Register

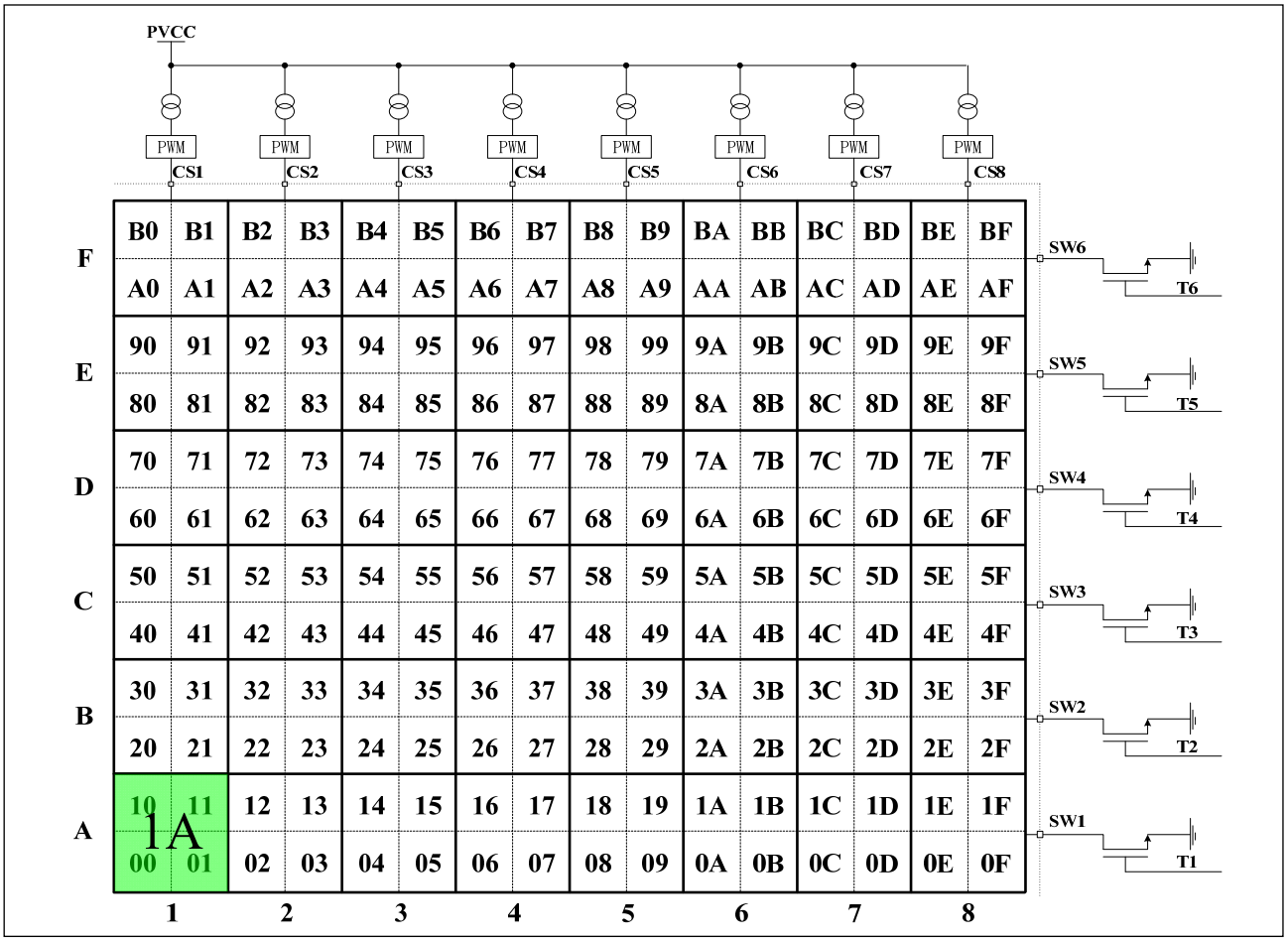
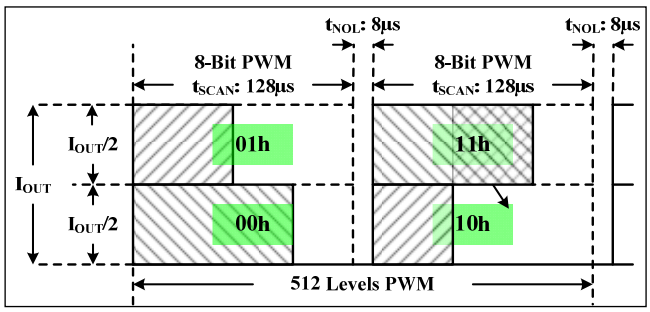


Figure 11 PWM Register

Table 10 00h ~ BFh PWM Register

Bit	D7:D0
Name	PWM
Default	0000 0000

Each dot has 4 bytes to modulate the PWM duty in 512 steps. Each byte controls half of the I_{OUT} and half of the duty, like LED 1A (Figure 11), the current will be as shown below:



The value of the PWM Registers decides the average current of each LED noted I_{LED}.

I_{LED} computed by Formula (1):

$$I_{LED} = \frac{\sum PWM}{512} \times I_{OUT} \times Duty \qquad (1)$$

$$PWM = \sum_{n=0}^{7} D[n] \cdot 2^n$$

Where Duty is the duty cycle of SWy/2,

$$Duty = \frac{128\mu s}{(128\mu s + 8\mu s)} \times \frac{1}{6} \times \frac{1}{2} = \frac{1}{12.75} \qquad (2)$$

I_{OUT} is the output current of CSx (x=1~8),

$$I_{OUT} = \frac{840}{R_{EXT}} \times \frac{GCC}{256} \times 2 \qquad (3)$$

GCC is the Global Current Control register (PG3, 01h) value and R_{EXT} is the external resistor of R_EXT pin. D[n] stands for the individual bit value, 1 or 0, in location n.

For example 1:

If 00h=0xFF, 01h=0xFF, 10h=0xFF, 11h=0xFF, GCC=255. R_{EXT}=20kΩ (I_{OUT}=84mA),

$$I_{LED-1A} = \frac{0xff + 0xff + 0xff + 0xff}{512} \times I_{OUT} \times \frac{1}{12.75}$$

$$= 13.13mA$$

For example 2:

If 00h=0x80, 01h=0x80, 10h=0x80, 11h=0x00, GCC=255. R_{EXT}=20kΩ (I_{OUT}=84mA),

$$I_{LED-1A} = \frac{0x80 + 0x80 + 0x80 + 0x00}{512} \times I_{OUT} \times \frac{1}{12.75}$$

$$= 4.94mA$$

Table 6-4 Page 2 (PG2, 0x02): Auto Breath Mode Register

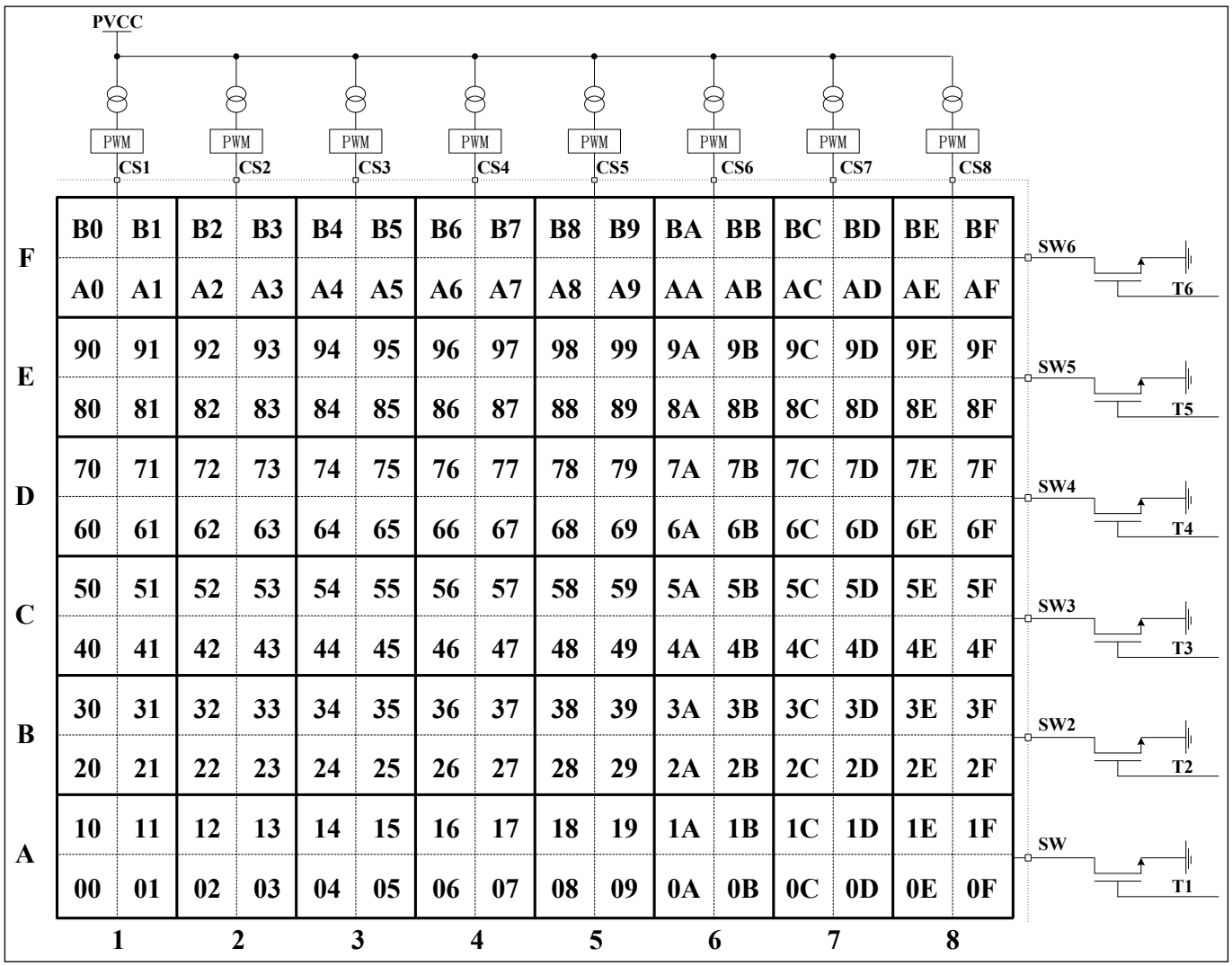


Figure 12 Auto Breath Mode Selection Register

Table 11 00h ~ BFh Auto Breath Mode Register

Bit	D7:D2	D1:D0
Name	-	ABMS
Default	000000	00

The Auto Breath Mode Register sets operating mode of each dot, notice four registers should be the same value when you selecting the mode.

For example, if 00h=0x01, 01h=0x01, 10h=0x01, 11h=0x01, then LED 1A works as ABM-1 mode.

ABMS Auto Breath Mode Selection Bit
00 PWM control mode
01 Select Auto Breath Mode 1 (ABM-1)
10 Select Auto Breath Mode 2 (ABM-2)
11 Select Auto Breath Mode 3 (ABM-3)

Table 12 Page 3 (PG3, 0x03): Function Register

Register	Name	Function	R/W	Default
00h	Configuration Register	Configure the operation mode	W	0000 0000
01h	Global Current Control Register	Set the global current	W	
02h	Auto Breath Control Register 1 of ABM-1	Set fade in and hold time for breath function of ABM-1	W	
03h	Auto Breath Control Register 2 of ABM-1	Set the fade out and off time for breath function of ABM-1	W	
04h	Auto Breath Control Register 3 of ABM-1	Set loop characters of ABM-1	W	
05h	Auto Breath Control Register 4 of ABM-1	Set loop characters of ABM-1	W	
06h	Auto Breath Control Register 1 of ABM-2	Set fade in and hold time for breath function of ABM-2	W	
07h	Auto Breath Control Register 2 of ABM-2	Set the fade out and off time for breath function of ABM-2	W	
08h	Auto Breath Control Register 3 of ABM-2	Set loop characters of ABM-2	W	
09h	Auto Breath Control Register 4 of ABM-2	Set loop characters of ABM-2	W	
0Ah	Auto Breath Control Register 1 of ABM-3	Set fade in and hold time for breath function of ABM-3	W	
0Bh	Auto Breath Control Register 2 of ABM-3	Set the fade out and off time for breath function of ABM-3	W	
0Ch	Auto Breath Control Register 3 of ABM-3	Set loop characters of ABM-3	W	
0Dh	Auto Breath Control Register 4 of ABM-3	Set loop characters of ABM-3	W	
0Eh	Time Update Register	Update the setting of 02h ~ 0Dh registers	W	
0Fh	SWy Pull-Up Resistor Selection Register	Set the pull-up resistor for SWy	W	
10h	CSx Pull-Down Resistor Selection Register	Set the pull-down resistor for CSx	W	
11h	Reset Register	Reset all register to POR state	R	

Table 13 00h Configuration Register

Bit	D7:D6	D5:D3	D2	D1	D0
Name	SYNC	-	OSD	B_EN	SSD
Default	00	000	0	0	0

The Configuration Register sets operating mode of IS31FL3738.

When SYNC bits are set to “01”, the IS31FL3738 is configured as the master clock source and the SYNC pin will generate a clock signal distributed to the clock slave devices. To be configured as a clock slave device and accept an external clock input the slave device’s SYNC bits must be set to “10”.

When OSD set high, open/short detection will be trigger once, the user could trigger OS detection again by set OSD from 0 to 1.

When B_EN enable, those dots select working in ABM-x mode will start to run the pre-established timing. If it is disabled, all dots work in PWM mode. Following Figure 16 to enable the Auto Breath mode

When SSD is “0”, IS31FL3738 works in software shutdown mode and to normal operate the SSD bit should set to “1”.

SYNC Synchronize Configuration
00/11 High impedance
01 Master
10 Slave

OSD Open/Short Detection Enable Bit
0 Disable open/short detection
1 Enable open/short detection

B_EN Auto Breath Enable
0 PWM Mode enable
1 Auto Breath Mode enable

SSD Software Shutdown Control
0 Software shutdown
1 Normal operation

Table 14 01h Global Current Control Register

Bit	D7:D0
Name	GCCx
Default	0000 0000

The Global Current Control Register modulates all CSx (x=1~8) DC current which is noted as I_{OUT} in 256 steps.

I_{OUT} is computed by the Formula (3):

$$I_{OUT} = \frac{840}{R_{EXT}} \times \frac{GCC}{256} \qquad (3)$$

$$GCC = \sum_{n=0}^{7} D[n] \cdot 2^n$$

Where D[n] stands for the individual bit value, 1 or 0, in location n, R_{EXT} is the external resistor of REXT pin.

For example: if D7:D0 = 1011 0101,

$$I_{OUT} = \frac{2^0 + 2^2 + 2^4 + 2^5 + 2^7}{256} \times \frac{840}{R_{EXT}}$$

Table 15 02h, 06h, 0Ah Auto Breath Control Register 1 of ABM-x

Bit	D7:D5	D4:D1	D0
Name	T1	T2	-
Default	000	0000	0

Auto Breath Control Register 1 set the T1&T2 time in Auto Breath Mode.

T1 T1 Setting
000 0.21s
001 0.42s
010 0.84s
011 1.68s
100 3.36s
101 6.72s
110 13.44s
111 26.88s

T2 T2 Setting
0000 0s
0001 0.21s
0010 0.42s
0011 0.84s
0100 1.68s
0101 3.36s
0110 6.72s
0111 13.44s
1000 26.88s
Others Unavailable

Table 16 03h, 07h, 0Bh Auto Breath Control Register 2 of ABM-x

Bit	D7:D5	D4:D1	D0
Name	T3	T4	-
Default	000	0000	0

Auto Breath Control Register 2 set the T3&T4 time in Auto Breath Mode.

T3 T3 Setting
000 0.21s
001 0.42s
010 0.84s
011 1.68s
100 3.36s
101 6.72s
110 13.44s
111 26.88s

T4 T4 Setting
0000 0s
0001 0.21s
0010 0.42s
0011 0.84s
0100 1.68s
0101 3.36s
0110 6.72s
0111 13.44s
1000 26.88s
1001 53.76s
1010 107.52s
Others Unavailable

Table 17 04h, 08h, 0Ch Auto Breath Control Register 3 of ABM-x

Bit	D7:D6	D5:D4	D3:D0
Name	LE	LB	LTA
Default	00	00	0000

Total loop times= LTA ×256 + LTB.

For example, if LTA=2, LTB=100, the total loop times is 256×2+100= 612 times.

For the counting of breathing times, do follow Figure 16 to enable the Auto Breath Mode.

If the loop start from T4,

T4->T1->T2->T3(1)->T4->T1->T2->T3(2)->T4->T1->... and so on.

If the loop not start from T4,

Tx->T3(1) ->T4->T1->T2->T3(2)->T4-> T1->... and so on.

If the loop ends at off state (End of T3), the LED will be off state at last. If the loop ends at on state (End of T1), the LED will run an extra T4&T1, which are not included in loop.

LE Loop End Time
00 Loop end at off state (End of T3)
01 Loop end at on state (End of T1)
Others Unavailable

LB Loop Beginning Time
00 Loop begin from T1
01 Loop begin from T2
10 Loop begin from T3
11 Loop begin from T4

LTA 8-11 Bits Of Loop Times
0000 Endless loop
0001 1
0010 2
… …
1111 15

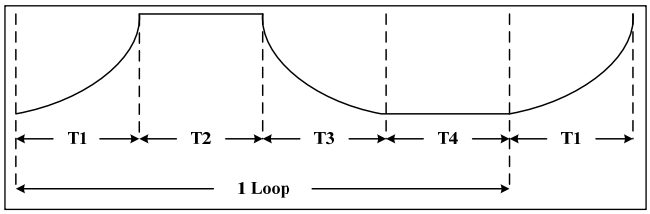


Figure 13 Auto Breathing Function

Table 18 05h, 09h, 0Dh Auto Breath Control Register 4 of ABM-x

Bit	D7:D0
Name	LTB
Default	0000 0000

Total loop times= LTA ×256 + LTB.

For example, if LTA=2, LTB=100, the total loop times is 256×2+100= 612 times.

LTB 0-7 Bits Of Loop Times
0000 0000 Endless loop
0000 0001 1
0000 0010 2
… …
1111 1111 255

0Eh Time Update Register (02h~0Dh)

The data sent to the time registers (02h~0Dh) will be stored in temporary registers. A write operation of "0000 0000" data to the Time Update Register is required to update the registers (02h~0Dh). Please follow Figure 16 to enable the Auto Breath mode and update the time parameters.

Table 19 0Fh SWy Pull-Up Resistor Selection Register

Bit	D7:D3	D2:D0
Name	-	PUR
Default	00000	000

Set pull-up resistor for SWy.

PUR SWy Pull-up Resistor Selection Bit
000 No pull-up resistor
001 0.5kΩ
010 1.0kΩ
011 2.0kΩ
100 4.0kΩ
101 8.0kΩ
110 16kΩ
111 32kΩ

Table 20 10h CSx Pull-Down Resistor Selection Register

Bit	D7:D3	D2:D0
Name	-	PDR
Default	00000	000

Set the pull-down resistor for CSx.

PDR	CSx Pull-down Resistor Selection Bit
000	No pull-down resistor
001	0.5kΩ
010	1.0kΩ
011	2.0kΩ
100	4.0kΩ
101	8.0kΩ
110	16kΩ
111	32kΩ

11h Reset Register

Once user read the Reset Register, IS31FL3738 will reset all the IS31FL3738 registers to their default value. On initial power-up, the IS31FL3738 registers are reset to their default values for a blank display.

APPLICATION INFORMATION

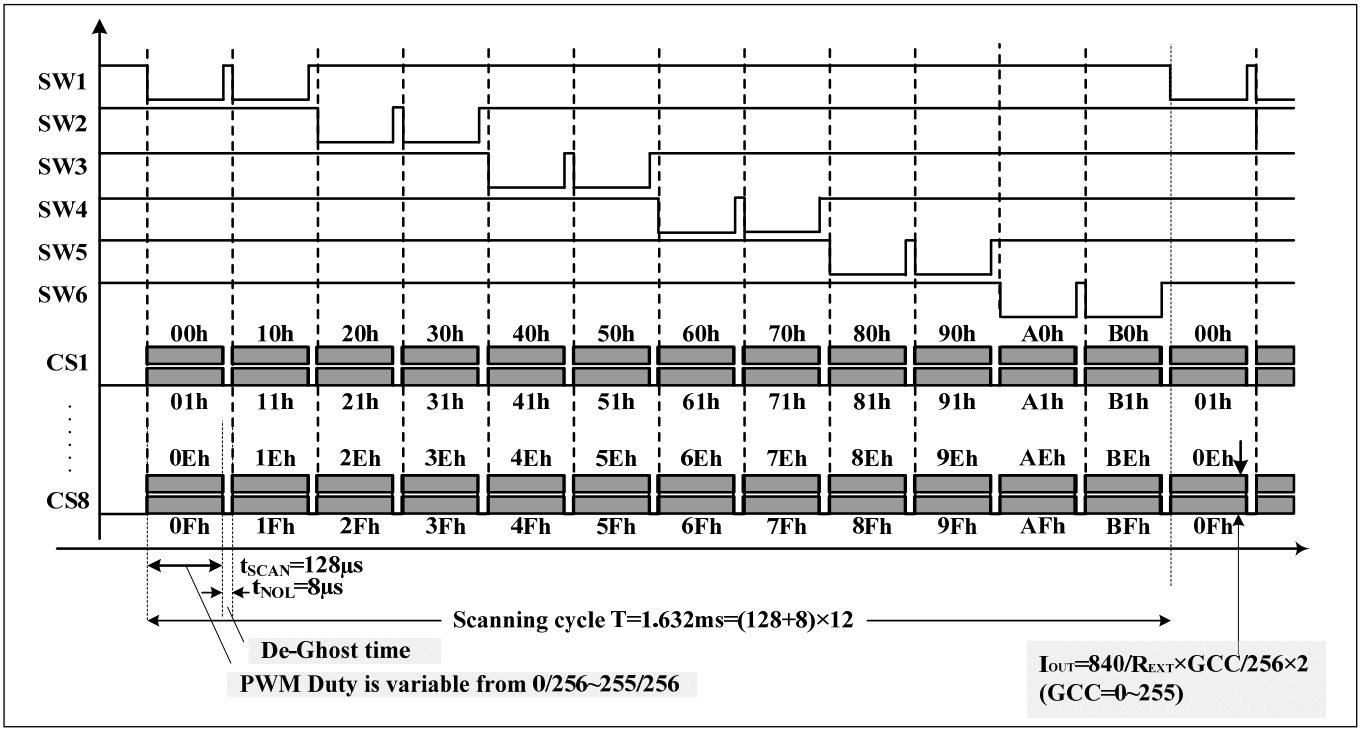


Figure 14 Scanning Timing

SCANING TIMING

As shown in Figure 12, the SW1~SW6 is turned on by serial, LED is driven 8 by 8 within the SWy (x=1~6) on time (SWy, y=1~6) is sink and pull low when LED on) , including the non-overlap blanking time during scan, the duty cycle of SWy (active low, y=1~6) is:

$$Duty=\frac{128\mu s}{(128\mu s+8\mu s)}\times\frac{1}{6}\times\frac{1}{2}=\frac{1}{12.75} \quad (2)$$

Where 128μs is t_{SCAN}, the period of scanning and 8μs is t_{NOL}, the non-overlap time.

EXTERNAL RESISTOR (R_{EXT})

The output current for each CSx can be can be set by a single external resistor, R_{EXT}, as described in Formula (3).

$$I_{OUT}=\frac{840}{R_{EXT}}\times\frac{GCC}{256}\times 2 \quad (3)$$

GCC is Global Current Control Register (PG3, 01h) data showing in Table 14.

PWM CONTROL

After setting the I_{OUT} and GCC, the brightness of each LEDs (LED average current (I_{LED})) can be modulated with 512 steps by PWM Register, as described in Formula (1).

$$I_{LED}=\frac{\sum PWM}{256}\times(I_{OUT}/2)\times Duty \quad (1)$$

Where PWM is PWM Registers (PG1, 00h~BFh) data showing in Table 10.

For example, in Figure 1, 00h=0xFF, 01h=0xFF, 10h=0xFF, 11h=0xFF, GCC=255. R_{EXT}=20kΩ (I_{OUT}=84mA),

$$I_{LED-1A}=\frac{0xff+0xff+0xff+0xff}{256}\times(I_{OUT}/2)\times\frac{1}{12.75}$$
$$=13.13mA$$

For example 2:

In Figure 1, 00h=0x80, 01h=0x80, 10h=0x80, 11h=0x00, GCC=255. R_{EXT}=20kΩ (IOUT=84mA),

$$I_{LED-1A}=\frac{0x80+0x80+0x80+0x00}{256}\times(I_{OUT}/2)\times\frac{1}{12.75}$$
$$=4.94mA$$

Writing new data continuously to the registers can modulate the brightness of the LEDs to achieve a breathing effect.

LED AVERAGE CURRENT (I_{LED})

As described in Formula (1), the LED average current (I_{LED}) is effected by 3 factors:

1. R_{EXT}, resistor which is connected R_EXT pin and GND. R_{EXT} sets the current of all CSx (x=1~8) based on Formula (3).

2. Global Current Control Register (PG3, 01h). This register adjusts all CSx (x=1~8) output currents by 256 steps as shown in Formula (3).

3. PWM Registers (PG1, 00h~BFh), every LED has an own PWM register. PWM Registers adjust individual LED average current by 512 steps as shown in Formula (1).

GAMMA CORRECTION

In order to perform a better visual LED breathing effect we recommend using a gamma corrected PWM value to set the LED intensity. This results in a reduced number of steps for the LED intensity setting, but causes the change in intensity to appear more linear to the human eye.

Gamma correction, also known as gamma compression or encoding, is used to encode linear luminance to match the non-linear characteristics of display. Since the IS31FL3738 can modulate the brightness of the LEDs with 512 steps, a gamma correction function can be applied when computing each subsequent LED intensity setting such that the changes in brightness matches the human eye's brightness curve.

Table 21 32 Gamma Steps with 256 PWM Steps

C(0)	C(1)	C(2)	C(3)	C(4)	C(5)	C(6)	C(7)
0	1	2	4	6	10	13	18
C(8)	C(9)	C(10)	C(11)	C(12)	C(13)	C(14)	C(15)
22	28	33	39	46	53	61	69
C(16)	C(17)	C(18)	C(19)	C(20)	C(21)	C(22)	C(23)
78	86	96	106	116	126	138	149
C(24)	C(25)	C(26)	C(27)	C(28)	C(29)	C(30)	C(31)
161	173	186	199	212	226	240	255

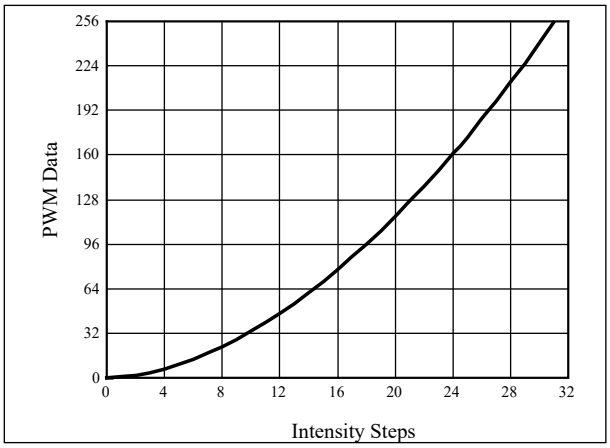


Figure 15 Gamma Correction (32 Steps)

Choosing more gamma steps provides for a more continuous looking breathing effect. This is useful for very long breathing cycles. The recommended configuration is defined by the breath cycle T. When T=1s, choose 32 gamma steps, when T=2s, choose 64 gamma steps. The user must decide the final number of gamma steps not only by the LED itself, but also based on the visual performance of the finished product.

Table 22 64 Gamma Steps with 256 PWM Steps

C(0)	C(1)	C(2)	C(3)	C(4)	C(5)	C(6)	C(7)
0	1	2	3	4	5	6	7
C(8)	C(9)	C(10)	C(11)	C(12)	C(13)	C(14)	C(15)
8	10	12	14	16	18	20	22
C(16)	C(17)	C(18)	C(19)	C(20)	C(21)	C(22)	C(23)
24	26	29	32	35	38	41	44
C(24)	C(25)	C(26)	C(27)	C(28)	C(29)	C(30)	C(31)
47	50	53	57	61	65	69	73
C(32)	C(33)	C(34)	C(35)	C(36)	C(37)	C(38)	C(39)
77	81	85	89	94	99	104	109
C(40)	C(41)	C(42)	C(43)	C(44)	C(45)	C(46)	C(47)
114	119	124	129	134	140	146	152
C(48)	C(49)	C(50)	C(51)	C(52)	C(53)	C(54)	C(55)
158	164	170	176	182	188	195	202
C(56)	C(57)	C(58)	C(59)	C(60)	C(61)	C(62)	C(63)
209	216	223	230	237	244	251	255

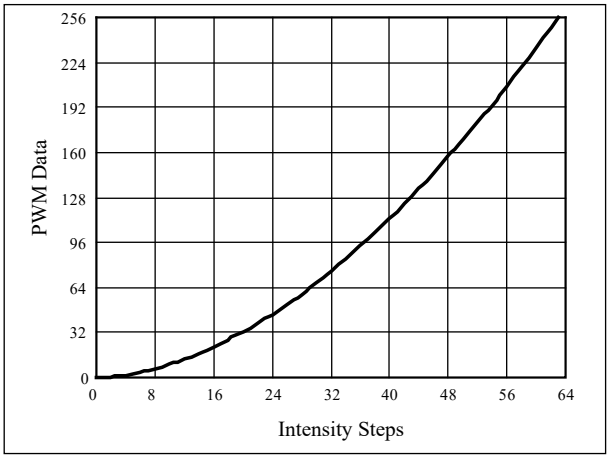


Figure 16 Gamma Correction (64 Steps)

Note: The data of 32 gamma steps is the standard value and the data of 64 gamma steps is the recommended value.

OPERATING MODE

Each dot of IS31FL3738 has two selectable operating modes, PWM Mode and Auto Breath Mode.

PWM Mode

By setting the Auto Breath Mode Register bits of the Page 2 (PG2, 00h~BFh) to “00”, or disable the B_EN bit of Configure Register (PG3, 00h), the IS31FL3738 operates in PWM Mode. The brightness of each LED can be modulated with 512 steps by PWM registers.

For example, if the data in PWM Register is “0000 0100”, then the PWM is the fourth step.

Writing new data continuously to the registers can modulate the brightness of the LEDs to achieve a breathing effect.

Auto Breath Mode

By setting the B_EN bit of the Configuration Register (PG3, 00h) to “1”, breath function enables. When set the B_EN bit to “0”, breath function disables.

By setting the Auto Breath Mode Register bits of the Page 2 (PG2, 00h~BFh) to “01” (ABM-1), “10” (ABM-2) or “11” (ABM-3), the IS31FL3738 operates in Auto Breath Mode.

IS31FL3738 has three auto breath modes, Auto Breath Mode 1, Auto Breath Mode 2 and Auto Breath Mode 3. Each ABM has T1, T2, T3 and T4, as shown below:

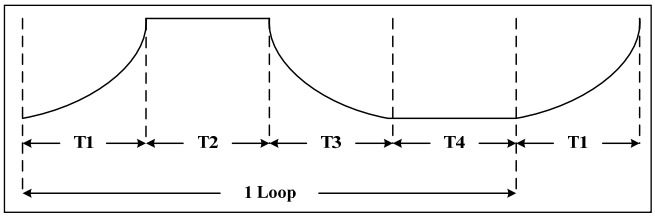


Figure 17 Auto Breathing Function

T1/T3 is variable from 0.21s to 26.88s, T2/T4 is variable from 0s to 26.88s, for each loop, the start point can be T1~T4 and the stop point can be on state (T2) and off state (T4), also the loop time can be set to $1\sim2^{12}$ times or endless. Each LED can select ABM-1~ABM-3 to work.

The setting of ABM-1~ABM-3 (PG2, 02h~0Dh) need to write the 0Eh in PG3 to update before effective.

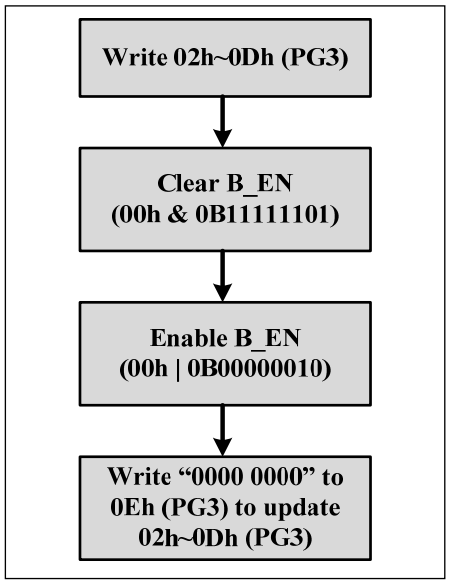


Figure 18 Enable Auto Breath mode

If not follow this flow, first loop’s start point may be wrong

OPEN/SHORT DETECT FUNCTION

IS31FL3738 has open and short detect bit for each LED.

By setting the OSD bit of the Configuration Register (PG3, 00h) from "0" to “1”, the LED Open Register and LED Short Register will start to store the open/short information and after at least 2 scanning cycle (3.264ms) the MCU can get the open/short information by reading the 18h~2fh/30h~47h, for those dots are turned off via LED On/Off Registers (PG0, 00h~17h), the open/short data will not get refreshed when setting the OSD bit of the Configuration Register (PG3, 00h) from "0" to “1”.

The Global Current Control Register (PG3, 01h) need to set to 0x01 in order to get the right open/short data.

The detect action is one-off event and each time before reading out the open/short information, the OSD bit of the Configuration Register (PG3, 00h) need to be set from "0" to “1” (clear before set operation).

INTERRUPT CONTROL

IS31FL3738 has an INTB pin, by setting the Interrupt Mask Register (F0h), it can be the flag of LED open, LED short or the finish flag of ABM-1, ABM-2, and ABM-3.

For example, if the IO bit of the Interrupt Mask Register (F0h) set to “1”, when LED open happens, the INTB will pull be pulled low and the OB bit of Interrupt Status Register (F1h) will store open status at the same time.

The INTB pin will be pulled high after reading the Interrupt Status Register (F1h) operation or it will be pulled high automatically after it stays low for 8ms (Typ.) if the IAC bit of Interrupt Mask Register (F0h) is set to “1”. The bits of Interrupt Status Register (F1h) will be reset to “0” after INTB pin pulled high.

SYNCHRONIZE FUNCTION

SYNC bits of the Configuration Register (PG3, 00h) sets SYNC pin input or output synchronize clock signal. It is used for more than one part working synchronize. When SYNC bits are set to “01”, SYNC pin output synchronize clock to synchronize other parts as master. When SYNC bits are set to “10”, SYNC pin input synchronize clock and work synchronization with this input signal as slave. When SYNC bits are set to “00/11”, SYNC pin is high impedance, and synchronize function is disabled. SYNC bit default state is “00” and SYNC pin is high impedance when power up.

DE-GHOST FUNCTION

The ‘ghost’ term is used to describe the behavior of an LED that should be OFF but instead glows dimly when another LED is turned ON. A ghosting effect typically can occur when multiplexing LEDs. In matrix

architecture any parasitic capacitance found in the constant-current outputs or the PCB traces to the LEDs may provide sufficient current to dimly light an LED to create a ghosting effect.

To prevent this LED ghost effect, the IS31FL3738 has integrated pull-up resistors for each SWy (y=1~6) and pull-down resistors for each CSx (x=1~8). Select the right SWy pull-up resistor (PG3, 0Fh) and CSx pull-down resistor (PG3, 10h) which eliminates the ghost LED for a particular matrix layout configuration.

Typically, selecting the 32kΩ will be sufficient to eliminate the LED ghost phenomenon.

The SWy pull-up resistors and CSx pull-down resistors are active only when the CSx/SWy outputs are in the OFF state and therefore no power is lost through these resistors

SHUTDOWN MODE

Shutdown mode can be used as a means of reducing power consumption. During shutdown mode all registers retain their data.

Software Shutdown

By setting SSD bit of the Configuration Register (PG3, 00h) to “0”, the IS31FL3738 will operate in software shutdown mode. When the IS31FL3738 is in software shutdown, all current sources are switched off, so that the matrix is blanked. All registers can be operated. Typical current consume is 3μA.

Hardware Shutdown

The chip enters hardware shutdown when the SDB pin is pulled low. All analog circuits are disabled during hardware shutdown, typical the current consume is 3μA.

The chip releases hardware shutdown when the SDB pin is pulled high. During hardware shutdown state Function Register can be operated.

If V_{CC} has risk drop below 1.75V but above 0.1V during SDB pulled low, please re-initialize all Function Registers before SDB pulled high.

LAYOUT

As described in external resistor (R_{EXT}), the chip consumes lots of power. Please consider below factors when layout the PCB.

1. The V_{CC} (PVCC, AVCC, VIO) capacitors need to close to the chip and the ground side should well connected to the GND of the chip.

2. R_{EXT} should be close to the chip and the ground side should well connect to the GND of the chip.

3. The thermal pad should connect to ground pins and the PCB should have the thermal pad too, usually this pad should have some via thru the PCB to other side’s ground area to help radiate the heat. About the thermal pad size, please refer to the land pattern of each package.

4. The CSx pins maximum current is 84mA (R_{EXT}=20kΩ), and the SWy pins maximum current is 672mA (R_{EXT}=20kΩ), the width of the trace, SWy should have wider trace then CSx.

5. In the middle of SDA and SCL trace, a ground line is recommended to avoid the effect between these two lines.

CLASSIFICATION REFLOW PROFILES

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150°C 200°C 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3°C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	217°C 60-150 seconds
Peak package body temperature (Tp)*	Max 260°C
Time (tp)** within 5°C of the specified classification temperature (Tc)	Max 30 seconds
Average ramp-down rate (Tp to Tsmax)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

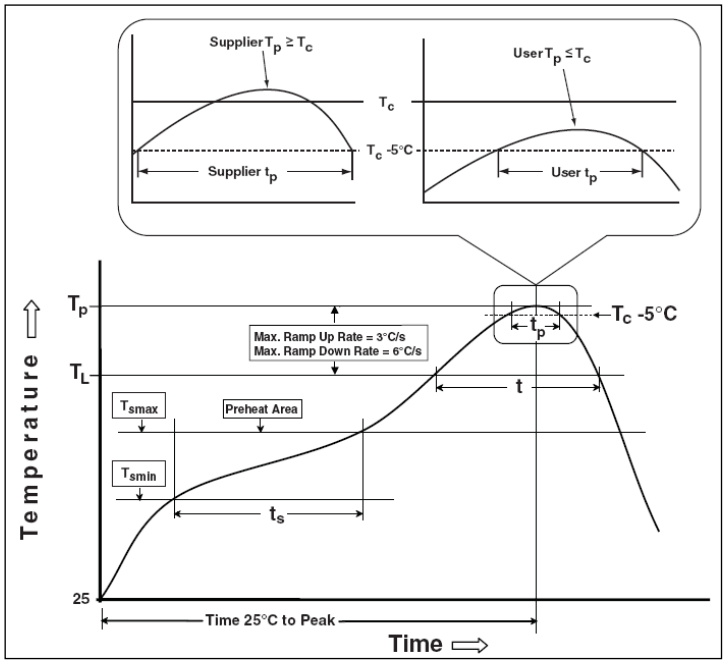
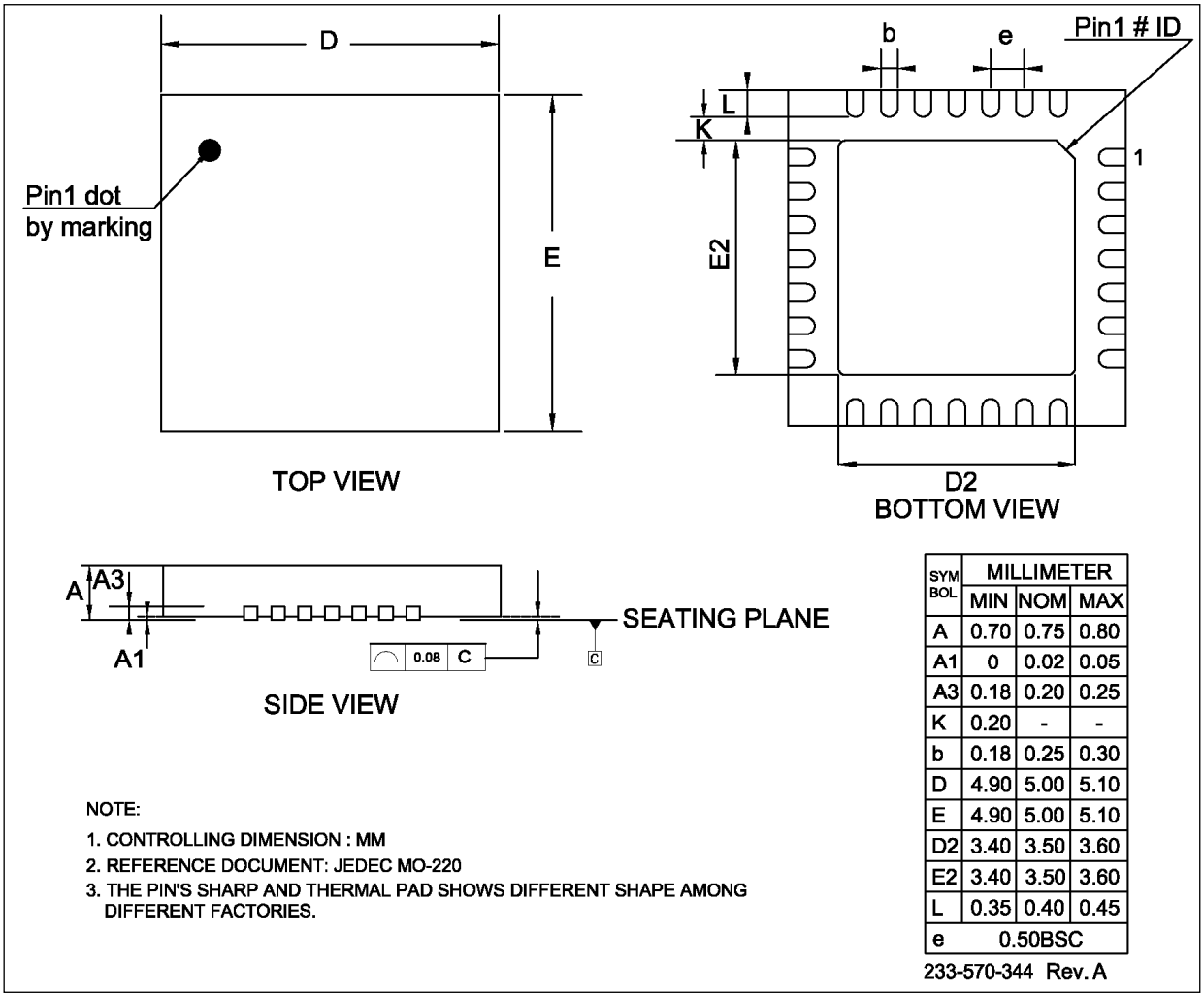


Figure 19 Classification Profile

PACKAGE INFORMATION

QFN-28



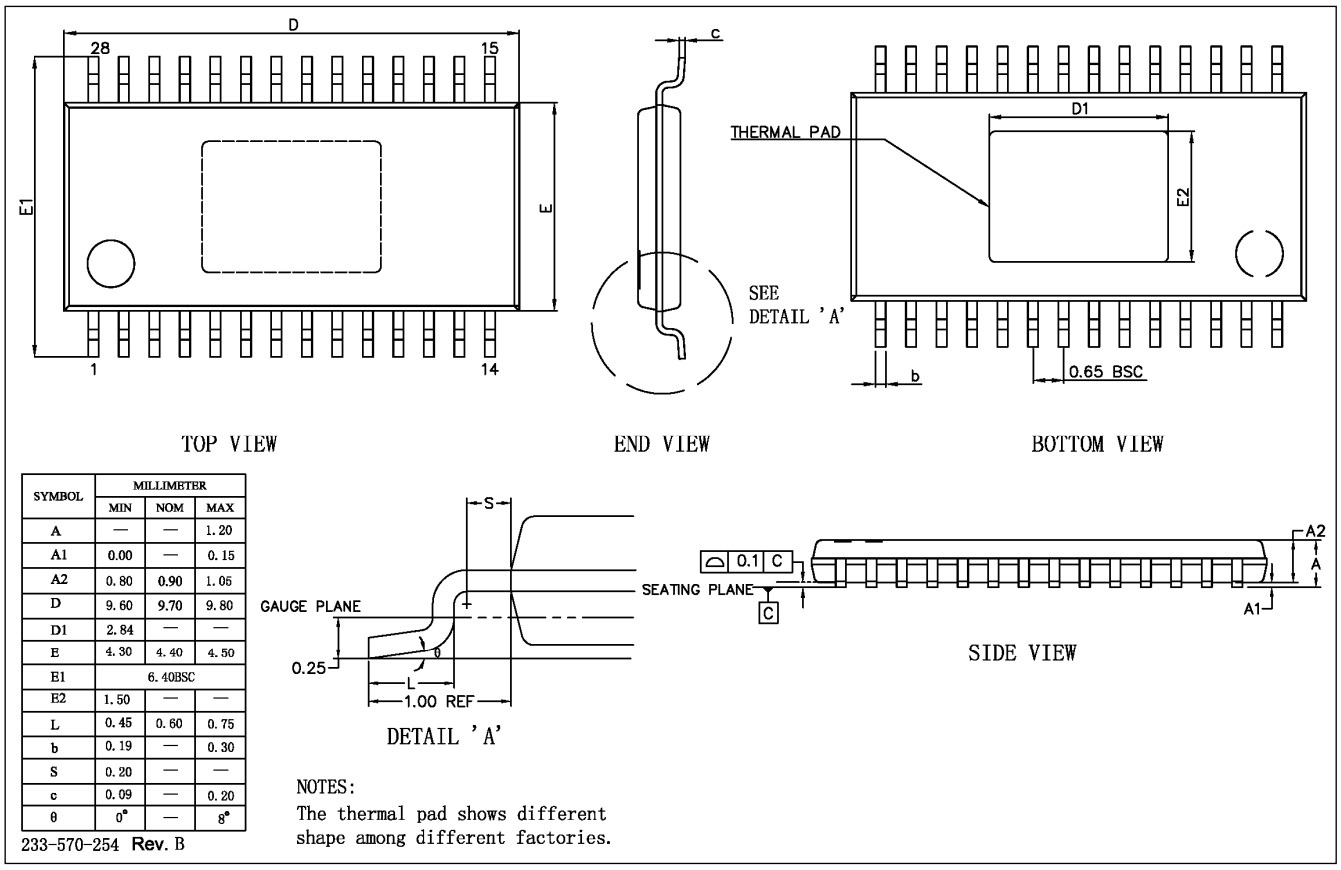
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0	0.02	0.05
A3	0.18	0.20	0.25
K	0.20	-	-
b	0.18	0.25	0.30
D	4.90	5.00	5.10
E	4.90	5.00	5.10
D2	3.40	3.50	3.60
E2	3.40	3.50	3.60
L	0.35	0.40	0.45
e	0.50BSC		

NOTE:

1. CONTROLLING DIMENSION : MM
2. REFERENCE DOCUMENT: JEDEC MO-220
3. THE PIN'S SHARP AND THERMAL PAD SHOWS DIFFERENT SHAPE AMONG DIFFERENT FACTORIES.

233-570-344 Rev. A

eTSSOP-28



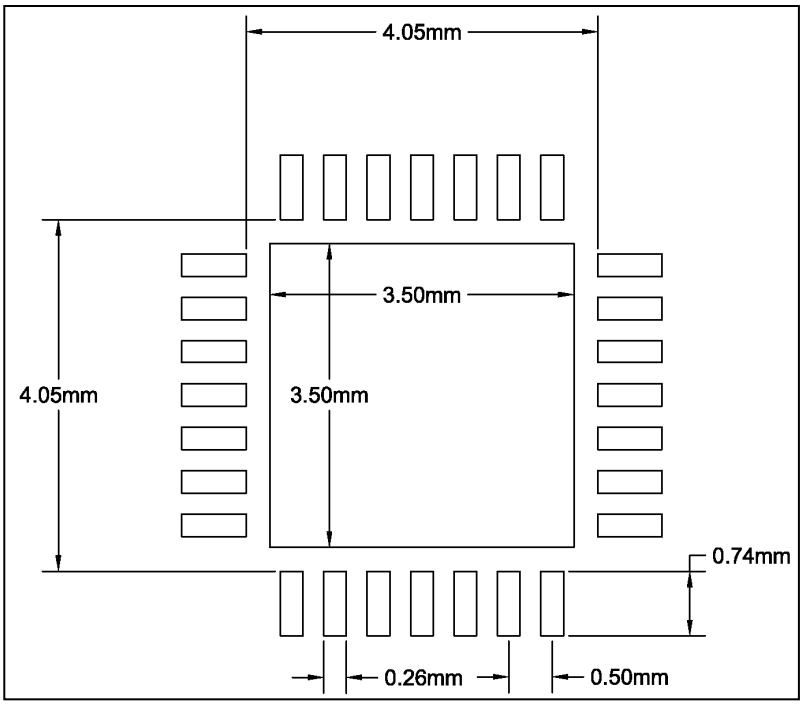
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	—	—	1.20
A1	0.00	—	0.15
A2	0.80	0.90	1.05
D	9.60	9.70	9.80
D1	2.84	—	—
E	4.30	4.40	4.50
E1	6.40BSC		
E2	1.50	—	—
L	0.45	0.60	0.75
b	0.19	—	0.30
S	0.20	—	—
c	0.09	—	0.20
θ	0°	—	8°

233-570-254 Rev. B

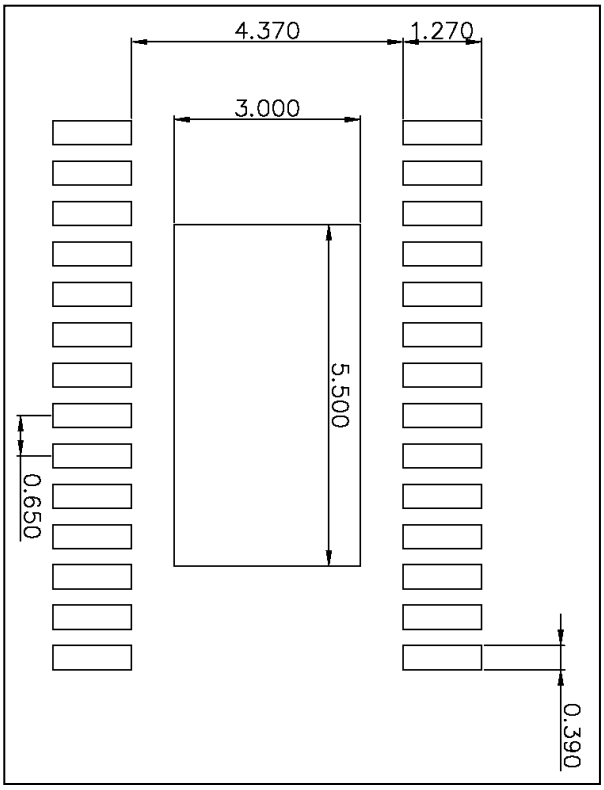
NOTES:
The thermal pad shows different shape among different factories.

RECOMMENDED LAND PATTERN

QFN-28



eTSSOP-28



Note:

1. Land pattern complies to IPC-7351.
2. All dimensions in MM.
3. This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown (eg. user's board manufacturing specs), user must determine suitability for use.

REVISION HISTORY

Revision	Detail Information	Date
0B	Initial release	2016.07.13
A	1. 1024 PWM steps change to 512, level, update Table 10 detail description and Formula (1) 2. Update the READING OPERATION section description 3. Correct Auto Breath Control Register 1~3 description 4. SDA/SCL pull-up resistor changes to 1kΩ in Figure 1 &2 5. Update ESD value	2017.05.15
B	Add eTSSOP-28 package information	2017.11.01
C	1. QFN-28,4mm×4mm changes to QFN-28,5mm×5mm 2. Add VIO description in Note 4 and EC table	2018.01.11
D	Add NRND watermark	2022.04.26
E	Remove NRND watermark	2022.08.01